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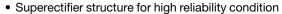
Vishay General Semiconductor

Glass Passivated Ultrafast Plastic Rectifier



PRIMARY CHARACTERISTICS						
I _{F(AV)}	3.0 A					
V_{RRM}	50 V, 100 V, 150 V, 200 V, 300 V, 400 V					
I _{FSM}	125 A					
t _{rr}	50 ns					
V_{F}	0.95 V, 1.25 V					
T _J max.	175 °C					
Package	DO-201AD					
Circuit configuration	Single					

FEATURES





COMPLIANT

• Cavity-free glass-passivated junction

cavity inco glass passivated junion

• Ultrafast reverse recovery time

Low forward voltage drop

Low leakage current

· Low switching losses, high efficiency

• High forward surge capability

• Solder dip 275 °C max. 10 s, per JESD 22-B106

 Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

TYPICAL APPLICATIONS

For use in high frequency rectification and freewheeling application in switching mode converters and inverters for consumer, computer, and telecommunication.

MECHANICAL DATA

Case: DO-201AD

Molding compound meets UL 94 V-0 flammability rating Base P/N-E3 - RoHS-compliant, commercial grade

Terminals: matte tin plated leads, solderable per

J-STD-002 and JESD 22-B102

E3 suffix meets JESD 201 class 1A whisker test **Polarity:** color band denotes cathode end

MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted)									
PARAMETER	SYMBOL	EGP31A	EGP31B	EGP31C	EGP31D	EGP31F	EGP31G	UNIT	
Maximum repetitive peak reverse voltage	V _{RRM}	50	100	150	200	300	400	V	
Maximum RMS voltage	V _{RMS}	35	70	105	140	210	280	V	
Maximum DC blocking voltage	V _{DC}	50	100	150	200	300	400	V	
Maximum average forward rectified current 0.375" (9.5 mm) lead length at T_L = 150 °C	I _{F(AV)}	3.0						А	
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I _{FSM}	125					Α		
Operating and storage temperature range	T _J , T _{STG}	, T _{STG} -65 to +175						°C	

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ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)										
PARAMETER	TEST CONDITIONS		SYMBOL	EGP31A	EGP31B	EGP31C	EGP31D	EGP31F	EGP31G	UNIT
Maximum instantaneous forward voltage	3.0 A		V _F ⁽¹⁾	0.95				1.25		V
Maximum DC reverse current at rated DC blocking voltage		$T_A = 25 ^{\circ}\text{C}$ $T_A = 125 ^{\circ}\text{C}$	I _R ⁽²⁾	5.0 100						μA
Maximum reverse recovery time	$I_F = 0.5$ $I_{rr} = 0.2$	A, I _R = 1.0 A, 5 A	t _{rr}	50					ns	
Typical junction capacitance	4.0 V, 1	MHz	CJ	117 48				8	pF	

Notes

(1) Pulse test: 300 µs pulse width, 1 % duty cycle

(2) Pulse test: pulse width, ≤ 40 ms

THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)								
PARAMETER	SYMBOL EGP31A EGP31B EGP31C EGP31D EGP31F EGP31G					UNIT		
Typical thermal resistance	R ₀ JA (1)(2)	55						-c/w
Typical thermal resistance	R ₀ JL (2)(3)	8.5						C/VV

Notes

- $^{(1)}$ The heat generated must be less than the thermal conductivity from junction-to-ambient: $dP_D/dT_J < 1/R_{\theta JA}$
- $^{(2)}$ Thermal resistance $R_{\theta JA}$ junction to ambient, $R_{\theta JL}$ junction to lead at 0.375" (9.5 mm) lead length (use DC test method)
- (3) Device mounted on 30 mm x 30 mm PCB pad size areas.

ORDERING INFORMATION (Example)								
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE				
EGP31G-E3/C	1.21	С	1400	13" diameter paper tape and reel				
EGP31G-E3/D	1.21	D	1000	Ammo pack packaging				

RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise noted)

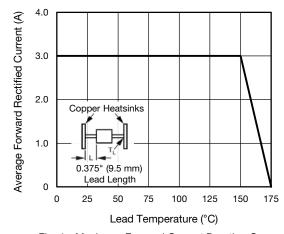


Fig. 1 - Maximum Forward Current Derating Curve

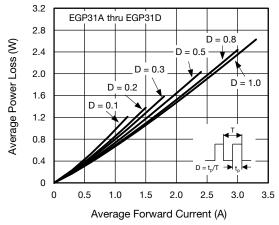


Fig. 2 - Forward Power Loss Characteristics

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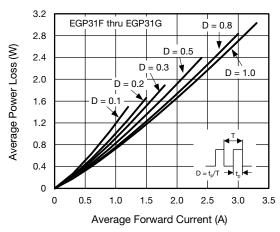
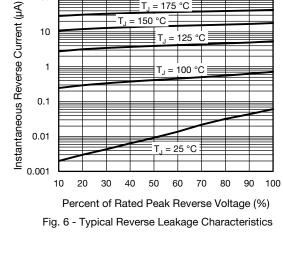


Fig. 3 - Forward Power Loss Characteristics



T_{.1} = 150 °C

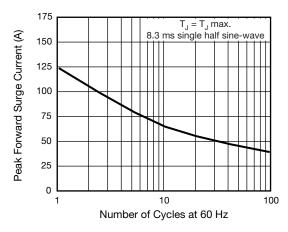


Fig. 4 - Maximum Non-Repetitive Peak Forward Surge Current

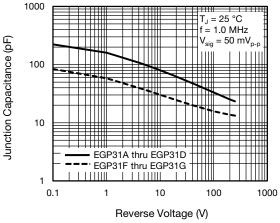


Fig. 7 - Typical Junction Capacitance

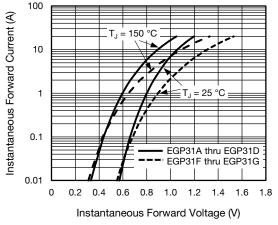


Fig. 5 - Typical Instantaneous Forward Characteristics

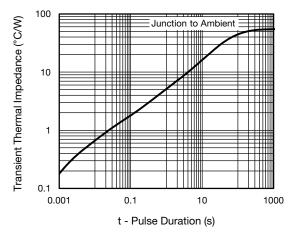


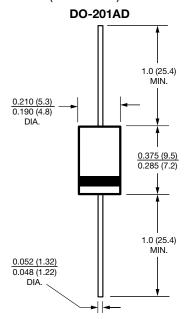
Fig. 8 - Typical Transient Thermal Impedance



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PACKAGE OUTLINE DIMENSIONS in inches (millimeters)



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